Low Quiescent, High Efficiency 3A Buck-Boost Converter with I²C Interface

General Description

The RT6160A is a high-efficiency, single inductor, Advanced Constant On-Time (ACOT[®]) monolithic synchronous Buck-Boost converter that can deliver up to 3A output current from 2.2V to 5.5V and well regulate to the digitally programmable output voltage from 2.025V to 5.2V, which is suitable for wide input supply range applications, regardless of input voltage is lower, higher than or even equal to the output voltage. The ACOT[®] control architecture features outstanding line/load transient response, seamless transition between buck and boost modes, provides stable operation with small ceramic output capacitors and without complicated external compensation.

The RT6160A features I²C interface, which allows programmable output voltage, ultra-sonic mode control, soft-start slew-rate adjusted and device status monitoring. The target output voltage can also be switched through external VSEL pin to perform dynamically-voltage-scaling (DVS), and the ramp-up slew-rate and ramp mode of DVS can also be set by setting the related registers.

The RT6160A operates in automatic PFM and typical 2μ A low quiescent current design that maintains high efficiency during light load operation. At higher loads, the device automatically switches to a 2.2MHz fixed frequency control, which is easily smoothed-out he switching ripple voltage by small package filtering elements. And the integrated low R_{DS(ON)} power MOSFETs features excellent efficiency during heavy load conditions. In shutdown mode, the supply current is typically 0.1 μ A, excellent in reducing power consumption. PFM mode can be disabled if fixed frequency is desired. The RT6160A is available in a small WL-CSP-15B 1.4x2.3 (BSC) package.

Features

- Automatic Seamless Mode Transition with Real Buck, Buck-Boost and Boost Operation
- Input Voltage Range : 2.2V to 5.5V
- Output Voltage Range : 2.025V to 5.2V with Digitally Programmable (25mV/steps)
- Default Output Voltage Setting :
 - ▶ V_{OUT} = 3.3V at VSEL = L
 - ▶ V_{OUT} = 3.45V at VSEL = H
- Maximum Continuous Output Current :
 - ▶ Up to 2.5A for $V_{IN} \ge 2.5V$, $V_{OUT} = 3.3V$
 - ▶ Up to 3A for $V_{IN} \ge 3V$, $V_{OUT} = 3.3V$
 - ▶ Up to 2A for $V_{IN} \ge 3V$, $V_{OUT} = 5V$
- Up to 95% Efficiency (V_{IN} = 3.8V, V_{OUT} = 3.3V, I_{LOAD} = 1A)
- 1µA Non-Switching Low Quiescent Current
- I²C Interface (Up to 1MHz)
- Allows Dynamically-Voltage-Scaling Control
- Automatic PFM Mode and Forced PWM Mode Selection
- Ultra-Sonic Mode Operation
- OCP, UVLO, OTP, OVP, UVP Protected Function for Robustness
- 15-Ball WL-CSP Package

Applications

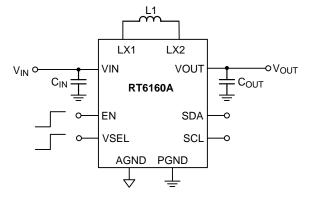
- Smartphones and Tablets
- Portable Devices
- Wearable Devices
- System Pre-Regulators
- Point-of-Load Regulators
- Wifi Module
- USB VCONN Supplies
- TWS Earbud Chargers

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Simplified Application Circuit



Ordering Information

RT6160A 🗖

Package Type WSC : WL-CSP-15B 1.4x2.3 (BSC)

Note :

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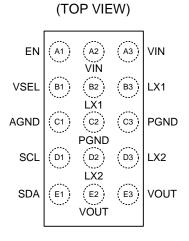
- ► RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

Marking Information

7RW

7R : Product Code W : Date Code

Pin Configuration



WL-CSP-15B 1.4x2.3 (BSC)

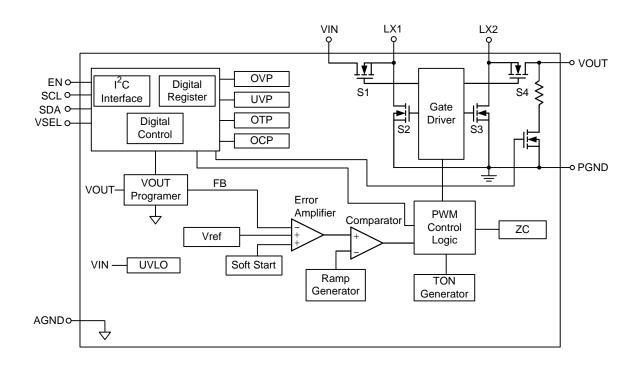
Functional Pin Description

| Pin No. | Pin Name | Pin Function |
|---------|----------|---|
| A1 | EN | Enable control input. A logic-high enables the converter; a logic-low forces the device into shutdown mode. |
| A2, A3 | VIN | Power input. The input voltage range is from 2.2V to 5.5V after soft-start is finished. Connect input capacitors between this pin and PGND with minimal path. It is recommended to use a 10μ F/6.3V/X5R/0402 and a 0.1μ F/6.3V/X5R/0201 ceramic capacitors. |
| B1 | VSEL | Voltage select pin. When this pin is tie to ground, V_{OUT} is set by the VOUT1 register; tie to logic-high, V_{OUT} is set by the VOUT2 register. |
| B2, B3 | LX1 | Switching node 1. Connect to the inductor. |
| C1 | AGND | Analog ground. All signals are referenced to this pin. Avoid routing high dV/dt AC currents through this pin. |
| C2, C3 | PGND | Power ground. The low-side MOSFET is referenced to this pin. C_{IN} and C_{OUT} should be returned with a minimal path to these pins. |

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| Pin No. | Pin Name | Pin Function |
|---------|----------|--|
| D1 | SCL | I^2C serial interface clock. This pin requires a pull-up resistor to I^2C power supply. |
| D2, D3 | LX2 | Switching node 2. Connect to the inductor. |
| E1 | SDA | I^2C serial interface data. This pin requires a pull-up resistor to I^2C power supply. |
| E2, E3 | VOUT | Output voltage sense through this pin. Connect to output capacitor. It is recommended to use two $22 \mu F/10 V/X5 R/0603$ ceramic capacitors. |

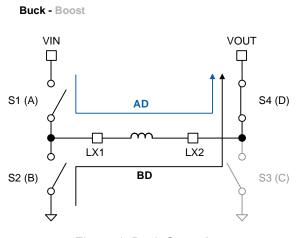
Functional Block Diagram

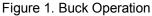


Operation

The RT6160A is a high-efficiency, single inductor, Advanced Constant On-Time ACOT® mode control mechanism to achieve fast-transient response and good stability with low-ESR ceramic capacitors. The ACOT[®] control scheme uses a virtual inductor current ramp generated inside the IC. This internal ramp signal replaces the ESR ramp normally provided by the output capacitor's ESR. The ramp signal and other internal compensations are optimized for low-ESR ceramic output capacitors.

Buck Operation





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When $V_{IN} > V_{OUT}$, the device switches like a buck converter. In steady-state buck-mode operation. The on-time one-shot turns on the high-side switch S1 (S4 keeps on) and the inductor current ramps up linearly. After the on-time, the high-side switch S1 is turned off and the synchronous rectifier switch S2 is turned on (S4 keeps on) and the inductor current ramps down linearly.

Boost Operation

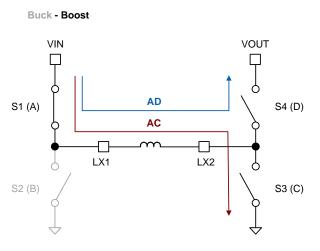


Figure 2. Boost Operation

When V_{IN} < V_{OUT} , the device switches like a boost converter. In boost mode at light load condition, the converter turns the S3 switch on (S1 keeps on) for a constant on-time as the one-shot is triggered, and the inductor current ramps up linearly. After the on-time, the S3 switch is turned off, and the synchronous rectifier switch S4 is turned on for a certain time (S1 keeps on) and the inductor current ramps down linearly. The S4 will turn off when inductor current drop zero. As the loading current increases and the device operates in continuous-conduction mode (CCM). When the feedback signal is less than the reference, the device turns switch S3 on (S1 keeps on) after the off-time oneshot is cleared and the inductor current ramps up linearly. Then the off-time one-shot turns S4 on (S1 keeps on) and the inductor current ramps down linearly.

Buck-Boost Operation

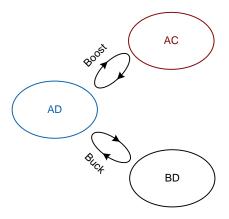


Figure 3. Buck-Boost Operation

When $V_{IN} \approx V_{OUT}$, all four transistors switch continuously, the device operates in buck-boost mode. In buck-boost mode at light-load condition, the device turns switches S1 and S3 on, and the inductor current increases linearly before reaching target peak-current level. When inductor current reaches peak-current level, the S1 and S4 are turned on for a constant time and the inductor current decreases linearly, and then the S2 and S4 switches are turned on to make sure the inductor will decrease to zero level. At light-load condition, the frequency increases as the loading increases. After the loading current is large enough, the converter will escape boundary-conduction mode and enter continuous-conduction mode. Furthermore, when VIN is close to VOUT in CCM, the switching frequency will decrease to half of the nominal switching frequency and the device will keep output voltage well-tracking as the target VOUT.

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Absolute Maximum Ratings (Note 1)

| Input Voltage, VIN | -0.3V to 6V |
|--|----------------|
| Output Voltage, VOUT | -0.3V to 6.2V |
| Switch Node Voltage, LX1, LX2 | -0.3V to 6V |
| <50ns | -5V to 8.5V |
| Other I/O Pins Voltages (EN, VSEL, SCL, SDA) | -0.3V to 6V |
| • Power Dissipation, $P_D @ T_A = 25^{\circ}C$ | |
| WL-CSP-15B 1.4x2.3 (BSC) | 1.88W |
| Package Thermal Resistance (Note 2) | |
| WL-CSP-15B 1.4x2.3 (BSC), θJA | 53°C/W |
| Junction Temperature | 150°C |
| Lead Temperature (Soldering, 10 sec.) | 260°C |
| Storage Temperature Range | –65°C to 150°C |
| • ESD Susceptibility (Note 3) | |
| HBM (Human Body Model) | 2kV |

Recommended Operating Conditions (Note 4)

| Input Voltage, V _{IN} | 2.2V to 5.5V |
|---|------------------------------|
| Output Voltage, Vour | 2.025V to 5.2V |
| Output Current, IOUT | 0A to 3A |
| Input Capacitance, CIN (Note 5) | 5μF (Min.) |
| Output Capacitance, C _{OUT} (Note 5) | 16μF (Min.) |
| Inductance, L | $0.39 \mu H$ to $0.56 \mu H$ |
| Ambient Temperature Range | –40°C to 85°C |
| Junction Temperature Range | –40°C to 125°C |

Electrical Characteristics

(V_IN = 3.6V, V_{OUT} = 3.3V, T_A = T_J = 25^{\circ}C, unless otherwise specified)

| Parameter | Symbol | Test Conditions | Min | Тур | Мах | Unit | |
|--|-------------------|---|------|------|------|------|--|
| Input Operating Voltage | VIN | | 2.2 | | 5.5 | V | |
| Positive-Going UVLO Threshold Voltage | VUVLO(POS) | V _{IN} rising | 2.11 | 2.14 | 2.17 | V | |
| Negative-Going UVLO Threshold Voltage | VUVLO(NEG) | | 2.02 | 2.05 | 2.08 | V | |
| UVLO Threshold Voltage Hysteresis | VUVLO(HYS) | | | 90 | | mV | |
| | I _{Q_SW} | $V_{EN} = V_{IN} = 3.6V, I_{OUT} = 0A$ | | 2 | 4 | | |
| Quiescent Current | IQ_NON-SW | $V_{EN} = V_{IN} = 3.6V$, $I_{OUT} = 0A$, not switching | | 1 | 2 | μA | |
| Shutdown Current | ISHDN | V _{EN} = 0V, V _{IN} = 3.6V | | 0.1 | 1 | μΑ | |

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| Parameter | Symbol | Test Conditions | Min | Тур | Мах | Unit | |
|--|------------------------|---|-------|------|-----|------|--|
| High-Level Input Current | Іін | VSCL = VSDA = VSEL = 1.8V, no pull-up resistor | | | 0.1 | μA | |
| Low-Level Input Current | IIL | VSCL = VSDA = VSEL = 0V, no pull-up resistor | | - | 0.1 | μA | |
| Input Bias Current | lıв | V _{EN} = 0 to 5.5V | | | 0.1 | μΑ | |
| High-Side Switch Leakage Current | IHS_LK | $V_{EN} = 0V, V_{SW} = 0V$ | | 1 | | μΑ | |
| High-Side Switch On-Resistance | R _{DS(ON)} _H | | | 25 | | mΩ | |
| Low-Side Switch On-Resistance | R _{DS(ON)} _L | | | 38 | | mΩ | |
| Output Discharge Resistor | R_DIS_OUT | $V_{EN} = 0V$ | | 5 | | Ω | |
| Enable Input High Threshold | VENH | V _{IN} = 2.2V to 5.5V | 1.2 | | | V | |
| Enable Input Low Threshold | V _{ENL} | V _{IN} = 2.2V to 5.5V | | | 0.4 | V | |
| (SCL, SDA, VSEL) Input High Threshold | VIH | | 1.2 | | | V | |
| (SCL, SDA, VSEL) Input Low Threshold | VIL | | | | 0.4 | V | |
| Output Voltage Range | Vout | | 2.025 | | 5.2 | V | |
| | VSEL_L | V _{SEL} = low | | 3.3 | | V | |
| Default Output Voltage | V _{SEL_H} | V _{SEL} = high | | 3.45 | | | |
| | ACC_Forced | Forced PWM operation | -1 | | 1 | | |
| Output Voltage Accuracy | ACC_AUTO | Auto PFM operation | -1 | | 3 | % | |
| | ACC_USC | Ultra-Sonic operation | -1 | | 3 | - | |
| Line Regulation | Vout_line_ reg | (Note 6) | | 0.5 | | % | |
| Load Regulation | Vout_load_ reg | (Note 6) | | 0.5 | | % | |
| Maximum Continuous Output | | $ \begin{array}{l} V_{\text{IN}} \geq 2.5 \text{V}, \ V_{\text{OUT}} = 3.3 \text{V}, \\ \text{L} = 0.47 \mu \text{H}, \ \text{C}_{\text{IN}} = 10 \mu \text{F}, \\ \text{C}_{\text{OUT}} = 44 \mu \text{F} (\text{Note 7}) \end{array} $ | 2.5 | | | ٨ | |
| Current | Iout_max | $\label{eq:VIN} \begin{array}{l} V_{IN} \geq 3V, \ V_{OUT} = 3.3V, \\ L = 0.47 \mu H, \ C_{IN} = 10 \mu F, \\ C_{OUT} = 44 \mu F \qquad (Note\ 7) \end{array}$ | 3 | | | A | |
| High-Side MOSFET Peak Current Limit | ILIM_P | V _{IN} = 3.6V, V _{OUT} = 3.3V | 4.5 | 5 | 5.5 | А | |
| Low-Side MOSFET Valley Current Limit | ILIM_V | V _{IN} = 3.6V, V _{OUT} = 3.3V | 4 | 4.5 | 5 | A | |
| PFM to PWM Threshold Inductor Current | IL_T_PFM | $\label{eq:VIN} \begin{array}{l} V_{\text{IN}} = 3.6 \text{V}, \ V_{\text{OUT}} = 3.3 \text{V}, \\ \text{L} = 0.47 \mu \text{H}, \ \text{C}_{\text{IN}} = 10 \mu \text{F}, \\ \text{C}_{\text{OUT}} = 44 \mu \text{F} \end{array}$ | | 0.3 | | A | |



| _ | | | | - | | |
|---|-------------------------|---|------|-----|-----|------|
| Parameter | Symbol | Test Conditions | Min | Тур | Мах | Unit |
| | | $\label{eq:VIN} \begin{array}{l} V_{\text{IN}} = 3.3 \text{V}, \ V_{\text{OUT}} = 3.3 \text{V}, \\ I_{\text{OUT}} = 0.1 \text{A}, \ L = 0.47 \mu \text{H}, \\ C_{\text{IN}} = 10 \mu \text{F}, \ C_{\text{OUT}} = 44 \mu \text{F}, \\ \text{Auto PFM operation} \end{array}$ | | 95 | | |
| Efficiency | Eff | $V_{IN} = 3.3V, V_{OUT} = 3.3V,$ $I_{OUT} = 1A, L = 0.47\mu H,$ $C_{IN} = 10\mu F, C_{OUT} = 44\mu F,$ Forced PWM operation | | 94 | | % |
| Lindency | | $\label{eq:VIN} \begin{array}{l} V_{IN} = 3.8V, \ V_{OUT} = 3.3V, \\ I_{OUT} = 0.1A, \ L = 0.47 \mu H, \\ C_{IN} = 10 \mu F, \ C_{OUT} = 44 \mu F, \\ Auto \ PFM \ operation \end{array}$ | | 94 | | 70 |
| | | $\label{eq:VIN} \begin{array}{l} V_{\text{IN}} = 3.8 \text{V}, \ V_{\text{OUT}} = 3.3 \text{V}, \\ I_{\text{OUT}} = 1 \text{A}, \ L = 0.47 \mu \text{H}, \\ C_{\text{IN}} = 10 \mu \text{F}, \ C_{\text{OUT}} = 44 \mu \text{F}, \\ \text{Forced PWM operation} \end{array}$ | | 95 | | |
| Output Ripple Voltage | | $\label{eq:VIN} \begin{array}{l} V_{\text{IN}} = 3.3 \text{V}, \ V_{\text{OUT}} = 3.3 \text{V}, \\ I_{\text{OUT}} = 0.1 \text{A}, \ L = 0.47 \mu \text{H}, \\ C_{\text{IN}} = 10 \mu \text{F}, \ C_{\text{OUT}} = 44 \mu \text{F}, \\ \text{Auto PFM operation} \\ (\text{Note 6}) \end{array}$ | | 50 | | |
| | Vout_ripple | $\label{eq:VIN} \begin{array}{l} V_{IN} = 3.3V, \ V_{OUT} = 3.3V, \\ I_{OUT} = 1A, \ L = 0.47\muH, \\ C_{IN} = 10\muF, \ C_{OUT} = 44\muF, \\ Forced \ PWM \ operation \\ (Note \ 6) \end{array}$ | | 20 | | mV |
| | | $ \begin{array}{l l} V_{IN} = 3.8V, \ V_{OUT} = 3.3V, \\ I_{OUT} = 0.1A, \ L = 0.47 \mu H, \\ C_{IN} = 10 \mu F, \ C_{OUT} = 44 \mu F, \\ Auto \ PFM \ operation \\ (Note \ 6) \end{array} \qquad 25 $ | | 25 | | mv |
| | | $\label{eq:VIN} \begin{array}{l} V_{IN} = 3.8V, \ V_{OUT} = 3.3V, \\ I_{OUT} = 1A, \ L = 0.47\muH, \\ C_{IN} = 10\muF, \ C_{OUT} = 44\muF, \\ Forced \ PWM \ operation \\ (Note \ 6) \end{array}$ | | 10 | | |
| Load Transient Personse | Vout_load_ | | -100 | | 100 | mV |
| Load Transient Response | TRANSIENT | | -50 | | 50 | 1117 |
| Line Transient Response | Vout_line_ transient | $I_{OUT} = 1A, V_{IN} = 3V \text{ to } 3.6V$ to 3V, $t_R = t_F = 10 \mu s$ (Note 6) | -50 | | 50 | mV |
| Switching Frequency | fsw | Boost or Buck operation | - | 2.2 | | MHz |
| Switching Frequency Range | f _{SW_RANGE} | Forced PWM operation, I _{OUT} = 100mA | 0.5 | | 3 | MHz |
| Switching Frequency at Ultra- Sonic Mode | fsw_usc | I _{OUT} = 1mA | 30 | | | kHz |

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| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit | |
|---|----------------------|--|-----|-----|------|------|--|
| Minimum On-Time | t _{ON_MIN} | | 20 | | 60 | ns | |
| Minimum Off-Time | toff_min | | 20 | | 60 | ns | |
| Output Voltage Rising Time | t _{R(SS)} | Output voltage ramp to output voltage 95%, L = 0.47μ H, C _{IN} = 10μ F, C _{OUT} = 44μ F | | 300 | 1000 | μS | |
| Enable Delay Time | tD(EN) | Enable pin logic-high to output voltage ramp, L = 0.47μ H, C _{IN} = 10μ F, C _{OUT} = 44μ F | | 220 | 300 | μS | |
| VSEL Delay Time | t _{D(VSEL)} | Delay between rising edge of V _{SEL} and start of DVS ramp | | 30 | | μs | |
| Positive-Going Under-Voltage Threshold Voltage | UVP+ | | | 95 | | % | |
| Negative-Going Under-Voltage Threshold Voltage | UVP- | | | 90 | | % | |
| | | 0x01, bit[1:0] = 00b | 0.8 | 1 | 1.2 | | |
| Output Voltage Dynamic Voltage | | 0x01, bit[1:0] = 01b | 2 | 2.5 | 3 | 1,,, | |
| Scaling Slew Rate | DVS_SR | 0x01, bit[1:0] = 10b | 4 | 5 | 6 | V/ms | |
| | | 0x01, bit[1:0] = 11b | 8 | 10 | 12 | 1 | |
| Thermal Shutdown | T _{SD} | (Note 6) | 140 | 150 | 160 | °C | |
| Thermal Shutdown Hysteresis | ΔT_{SD} | (Note 6) | | 20 | | °C | |

I²C Characteristics

| Parameter | Symbol | Test Conditions | Min | Тур | Мах | Unit | |
|--|----------------------------------|-----------------|------|-----|------|------|--|
| Logic Output Threshold Voltage (SCL, SDA, VSEL) | VI ² COL | | | | 0.4 | V | |
| I ² C Work Voltage | VI ² Cint | | | 1.8 | | V | |
| Input Current Each IO Pin | IIN_I ² C | | -10 | | 10 | μΑ | |
| Data Set-Up Time | t _{DS_l} ² c | | 70 | | | ns | |
| SCL Clock Frequency | fclk | Standard mode | | | 100 | kHz | |
| | | Fast mode | | | 400 | | |
| | | Fast mode plus | | | 1000 | | |
| | tBUF | Standard mode | 4.7 | | | | |
| Bus Free Time between Stop and Start Condition | | Fast mode | 1.3 | | | μS | |
| | | Fast mode plus | 0.5 | | | | |
| | | Standard mode | 4.7 | | | μS | |
| Hold Time (Repeated) | thd;sta | Fast mode | 0.6 | | | | |
| | | Fast mode plus | 0.26 | | | | |

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| Parameter | Symbol | Test Conditions | Min | Тур | Мах | Unit | | |
|--|---------------------|-----------------|------|-----|------|------|--|--|
| | | Standard mode | 4.7 | | | | | |
| Set-Up Time for a Repeated START Condition | tsu;sta | Fast mode | 0.6 | | | μS | | |
| | | Fast mode plus | 0.26 | | | | | |
| | | Standard mode | 0.1 | | | | | |
| Data Hold Time | t _{HD;DAT} | Fast mode | 0.1 | 1 | | ns | | |
| | | Fast mode plus | 0.1 | | | | | |
| | | Standard mode | 4 | - | | | | |
| Set-Up Time for STOP Condition | tsu;sто | Fast mode | 0.6 | | | μs | | |
| | | Fast mode plus | 0.26 | | | | | |
| | tvd;ack | Standard mode | | | 3.45 | μs | | |
| Data Valid Acknowledge Time | | Fast mode | | | 0.9 | | | |
| | | Fast mode plus | | | 0.45 | | | |
| | | Standard mode | 250 | | | | | |
| SDA Set-Up Time | tsu;dat | Fast mode | 100 | | | ns | | |
| | | Fast mode plus | 50 | | | 1 | | |
| | | Standard mode | 4.7 | | | | | |
| Low Period of the SCL Clock | tLOW | Fast mode | 1.3 | | | μS | | |
| | | Fast mode plus | 0.5 | | | 1 | | |
| | | Standard mode | 4 | | | | | |
| High Period of the SCL Clock | tнідн | Fast mode | 0.6 | | | μs | | |
| | | Fast mode plus | 0.26 | | | | | |

Note 1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

- **Note 2.** θ_{JA} is measured under natural convection (still air) at $T_A = 25^{\circ}C$ with the component mounted on a high effective-thermalconductivity four-layer test board on a JEDEC 51-7 thermal measurement standard.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- Note 5. Effective capacitance after DC bias effects have been considered.
- Note 6. Guaranteed by design.
- **Note 7.** The device can sustain the maximum recommended output current, Users must verify that the thermal performance of the end application can support the maximum output current.

Typical Application Circuit

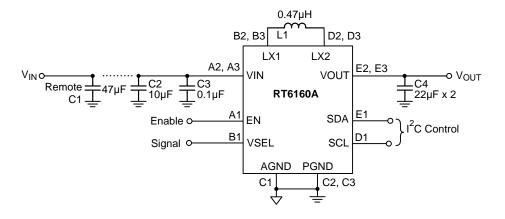


 Table 1. Recommended Components Information
 (Note 8)

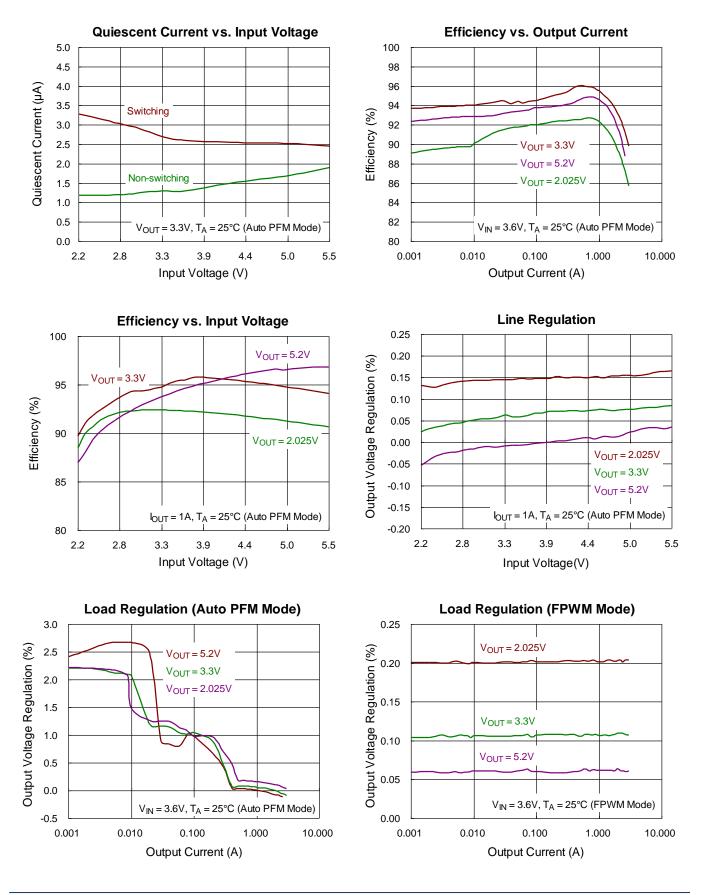
| Reference | Part Number | Description | Package | Manufacturer |
|-----------------|--------------------|----------------|-----------|--------------|
| C1 (Note 9) | GRM32ER61C476KE15 | 47µF/16V/X5R | 1210 | Murata |
| C2 | GRM155R60J106ME15 | 10µF/6.3V/X5R | 0402 | Murata |
| C3 (Note 10) | GRM033R60J104KE19D | 0.1µF/6.3V/X5R | 0201 | Murata |
| C4 | GRM188R61A226ME15D | 22µF/10V/X5R | 0603 | Murata |
| L1 | XFL4015-471MEC | 0.47µH | 4x4x1.5mm | Coilcraft |

Note 8. All the input and output capacitors are the suggested values, referring to the effective capacitances, subject to any derating effect, like a DC bias.

Note 9. The decoupling capacitor C1 is Remote C_{OUT} capacitor. C1 is optional. The device is designed to operate with a DC supply voltage in the range 2.2V to 5.5V. If the input supply is more than a few centimeters from the device, we recommend you add some bulk capacitance to the ceramic bypass capacitors. A 47μF electrolytic capacitor is a typical selection for the bulk capacitance.

Note 10. The decoupling capacitor C3 is recommended to reduce any high frequency component on VIN bus. C3 is optional and used to filter any high frequency component on VIN bus.

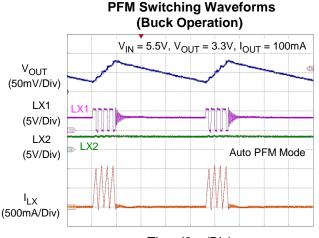
Typical Operating Characteristics



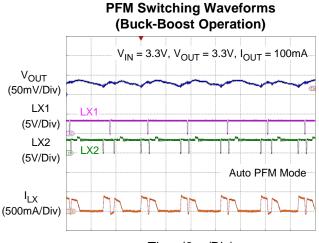
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Time (2µs/Div)



Time (2µs/Div)

PWM Switching Waveforms

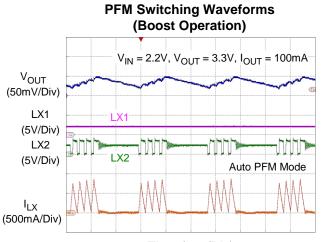
(Buck Operation)

innanananananananananananananana

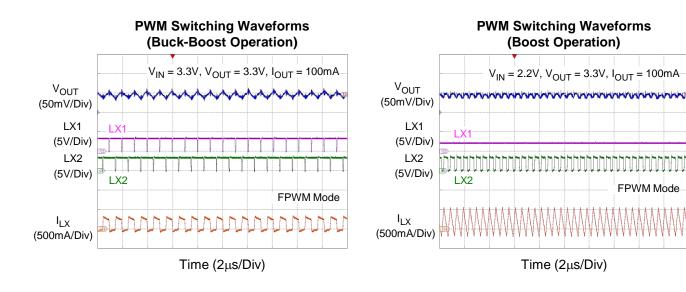
Time (2µs/Div)

V_{IN} = 5.5V, V_{OUT} = 3.3V, I_{OUT} = 100mA,

FPWM Mode



Time (2µs/Div)



VOUT

(50mV/Div)

LX1

(5V/Div)

LX2

(5V/Div)

 I_{LX}

(500mA/Div)

 $\left| \right\rangle$

LX2

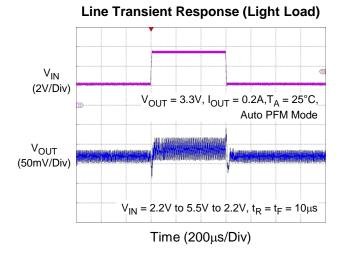
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V_{IN}

(500mV/Div)

VOUT (20mV/Div)

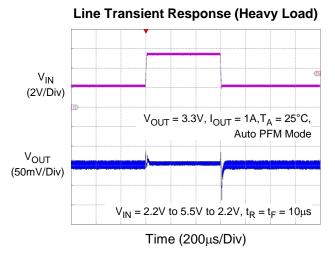


Line Transient Response (SPEC Condition)

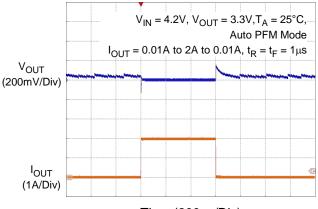
 $V_{OUT} = 3.3V, I_{OUT} = 1A, T_A = 25^{\circ}C,$

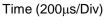
 $V_{IN} = 3V$ to 3.6V to 3V, $t_R = t_F = 10\mu s$

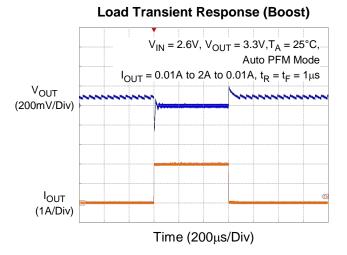
Auto PFM Mode



Load Transient Response (Buck)



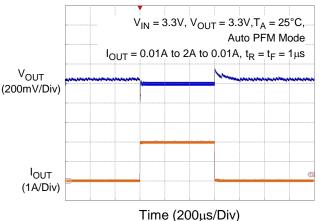




13



Time (200µs/Div)



ΕN

(2V/Div)

 V_{IN}

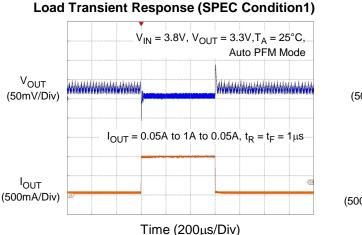
(2V/Div)

VOUT

(1V/Div)

ΕN



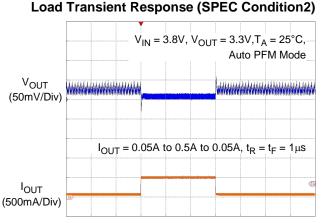


Start-Up Waveforms (Light Load)

 $R_{LOAD} = 33\Omega, T_A = 25^{\circ}C$, Auto PFM Mode

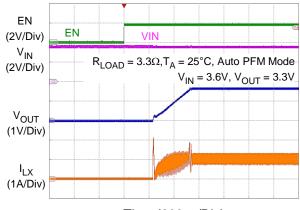
V_{IN} = 3.6V, V_{OUT} = 3.3V

VIN

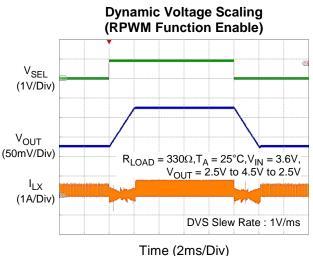


Time (200µs/Div)

Start-Up Waveforms (Heavy Load)



Time (200µs/Div)



ninta kini tahun d I_{LX} (1A/Div) Time (200µs/Div) **Dynamic Voltage Scaling** (RPWM Function Disable) VSEL (1V/Div)

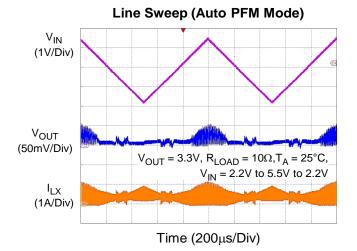
V_{OUT} (50mV/Div) $\mathsf{R}_{\mathsf{LOAD}} = 330\Omega, \mathsf{T}_{\mathsf{A}} = 25^{\circ}\mathsf{C}, \mathsf{V}_{\mathsf{IN}} = 3.6\mathsf{V},$ $V_{OUT} = 2.5V$ to 4.5V to 2.5V I_{LX} (1A/Div) DVS Slew Rate : 1V/ms

Time (2ms/Div)

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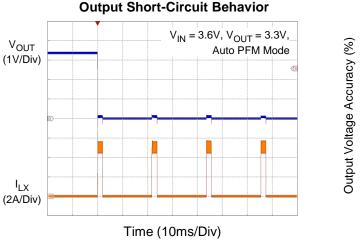


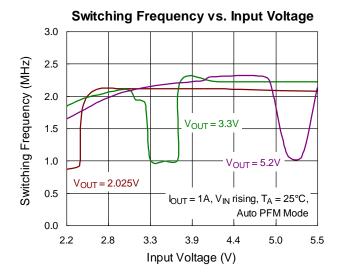
 I_{LX}



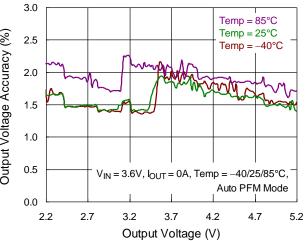
VIN (1V/Div) V_{OUT} (50mV/Div) $V_{OUT} = 3.3V, R_{LOAD} = 10\Omega, T_A = 25^{\circ}C,$ V_{IN} = 2.2V to 5.5V to 2.2V I_{LX} (1A/Div)

Time (200µs/Div)

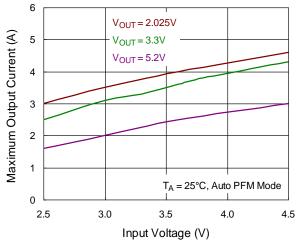




Output Voltage Accuracy



Maximum Output Current vs. Input Voltage



RT6160A

Application Information

The basic RT6160A application circuit is shown in Typical Application Circuit. External component selection is determined by the maximum load current and begins with the selection of the inductor value and operating frequency followed by C_{IN} and C_{OUT}.

Soft-Start

An internal current source charges an internal capacitor to build the soft-start ramp voltage. During the soft-start period, device sets \overline{PG} to "1" until VOUT reach 99% of its setting voltage.

The rise time of the output voltage changes with the application circuit and the operating conditions. The output voltage rise time increases if

- The load current is large
- The output capacitance is large

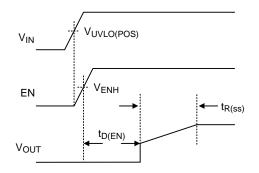


Figure 4. Soft-Start Sequence

Enable

The RT6160A provides an EN pin, as an external chip enable control, to enable or disable the device. If V_{EN} is held below a logic-low threshold voltage (V_{ENH} - Δ V_{EN}), switching is inhibited even if the VIN voltage is above V_{IN} under-voltage lockout threshold (V_{UVLO}). If V_{EN} is held below 0.4V, the converter will enter into shutdown mode, that is, the converter is disabled and will reset all registers to default value. During shutdown mode, the supply current can be reduced to I_{SHDN} (1µA or below). It's recommend that the V_{IN} voltage is higher than V_{UVLO} first, then the EN voltage rises above the logichigh threshold voltage (V_{ENH}) the device will be turned on, that is, switching being enabled and soft-start sequence being initiated. Note that, there is a 100μ s deglitch time for allowing I²C read/write when EN pin goes above logic-high threshold.

VSEL

VSEL = L output voltage default setting is 3.3V that can be programmed by Address 0x04[6:0] VOUT1.

VSEL = H output voltage default setting is 3.45V that can be programmed by Address 0x05[6:0] VOUT2.

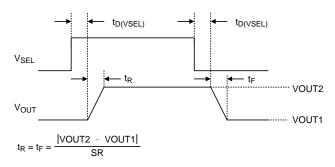


Figure 5. DVS Control the VSEL Pin

SR is the slew rate set by the (DVS Slew Rate) bits in the CONTROL register.

Auto PFM (Pulse Frequency Modulation) Mode

In order to save power and improve efficiency at low loads, the Buck/Boost operate in PFM (Pulse Frequency Modulation) mode as the inductor drops into DCM (Discontinuous Current Mode). The switching frequency is proportional to loading to reach output voltage regulation. When load increases and inductor current becomes continuous again, the Buck/Boost automatically goes back to PWM fixed frequency mode. Additionally, the RT6160A will enters DSLP (Deep Sleep) to reach input low quiescent current at no load. Auto PFM Mode is default mode.

FPWM (Forced Pulse Width Modulation) Mode

The switching frequency is forced into PWM mode operation. In this mode, the inductor current is in CCM (Continuous Current Mode) and the voltage is regulated by PWM.

To enable Forced-PWM operation, set the FPWM bit in the Control register to 1.

Ultra-Sonic Mode

To avoid acoustic noise problem when operation, the switching frequency is designed to be always higher than 30kHz even there is no load at output.

To enable Ultra-Sonic Mode operation, set the Ultra-Sonic Mode bit in the Control register to 1.

Ramp-PWM Function

If Ramp-PWM function is enabled, the device operates in forced-PWM when it ramps from one output voltage

to another during dynamic voltage scaling. This function is useful if you want the device to operate in Auto PFM Mode but you want to make sure that dynamic voltage scaling ramps the output voltage up and down in a controlled way. If the device operates in Auto PFM Mode and Ramp-PWM is disabled, the devices cannot always control the ramp from a higher output voltage to a lower output voltage, because in Automatic PFM/PWM Mode the devices cannot sink current.

To enable Ramp-PWM function, set the RAMP bit in the control register to 1.

To disable Ramp-PWM function, clear the RAMP bit in the control register to 0.

Dynamically Voltage Scaling Control

The RT6160A supports programmable slew-rate control feature when increasing and decreasing the output voltage, as known as Dynamically Voltage Scaling (DVS). The ramp slew-rate can be set to 1V/ms, 2.5V/ms, 5V/ms or 10V/ms through bit1 and bit0 of control register. Moreover, the operation mode during DVS region can be adjusted through control register bit2. When the device operates in Auto PFM/PWM mode, if the bit2 is set to 1, the device will change to Forced PWM mode operation during DVS region and back to auto PFM/PWM mode after reaching target output voltage. And the device will keep auto PFM/PWM mode during DVS region if the bit2 of control register is set to 0.

Output Discharge

The device actively discharges the output when the EN pin is low.

V_{OUT} Selection

The RT6160A has programmable V_{OUT} from 2.025V to 5.2V with 25mV resolution.

The output voltage can be set by VOUTx register bit and the output voltage is given by the following equation :

 $V_{OUT} = 2.025V + VOUTx \times 25mV$

For example :

if VOUTx = 110011 (51 decimal), then

 $V_{OUT} = 2.025V + 51 \times 25mV = 2.025V + 1.275V = 3.3V.$

The RT6160A also has external VSEL pin to select VOUT1(0X04) or VOUT2(0X05). Pulling VSEL to high is for VOUT2 and pulling VSEL to low is for VOUT1.

Upon POR, VOUT1 and VOUT2 are reset to their default voltages.

Power-Good Comparator

When a power-not-good condition occurs, the device sets the \overline{PG} bit in the Status register to 1. The device clears the \overline{PG} bit to 0 if you read the Status register when a power-good condition exists.

Auto-Zero Current Detector

The auto-zero current detector circuit senses the LX1 and LX2 waveform to adjust the zero current threshold voltage. When the current of low side MOSFET decrease to the zero current threshold. The low-side MOSFET turns off to prevent negative inductor current. In this way, the zero current threshold can adjust for different condition to get better efficiency.

Load Disconnect

During device shutdown, the input is disconnected from the output. This prevents any current flow from the output to the input or from the input to the output.

PWM Frequency and Adaptive On-Time Control

The on-time can be roughly estimated by the equation :

$$t_{ON} = \frac{V_{OUT}}{V_{IN}} \times \frac{1}{f_{SW}}$$

where f_{SW} is nominal 2.2MHz.



Inductor Selection

Inductor value choose will effect transient, ripple and other performance. The RT6160A recommended nominal inductance value is 0.47μ H to achieve advantage performance.

The inductor value and operating frequency determine the ripple current according to a specific input and output voltage. The ripple current ΔI_L increases with higher VIN and decreases with higher inductance.

$$\Delta \, I_L \; = \; \left(\frac{V_{O\,U\,T}}{f_{S\,W} \, \times L} \right) \times \left(1 - \frac{V_{O\,U\,T}}{V_{IN}} \right)$$

Having a lower ripple current reduces not only the ESR losses in the output capacitors but also the output voltage ripple. High frequency with small ripple current can achieve the highest efficiency operation. However, it requires a large inductor to achieve this goal.

For the ripple current selection, the value of ΔI_L which is I_{MAX} multiplied by 0.3 will be a reasonable starting point.

The largest ripple current occurs at the highest VIN. To guarantee that the ripple current stays below the specified maximum, the inductor value should be chosen according to the following equation :

$$L = \left(\frac{V_{OUT}}{f_{SW} \times \Delta I_{L(MAX)}}\right) \times \left(1 - \frac{V_{OUT}}{V_{IN(MAX)}}\right)$$

The inductor's current rating (caused a 40°C temperature rising from 25°C ambient) should be greater than the maximum load current and its saturation current should be greater than the short circuit peak current limit.

Input Capacitor Selection

Steady state and transient response operation performance also depend on input voltage stability or not. The RT6160A at least a 10μ F input capacitor is recommended to prevent input voltage instability with application operation. And that suggest placed as close as possible to the VIN and GND pins of the IC is recommended. If the input supply is more than a few centimeters from the device, we recommend you add some bulk capacitance to the ceramic bypass capacitors. A 47μ F electrolytic capacitor is a typical selection for the bulk capacitance.

Output Capacitor Selection

The ripple voltage is an important index for choosing output capacitor. This portion consists of two parts. One is the product of ripple current with the ESR of the output capacitor, while the other part is formed by the charging and discharging process of the output capacitor.

Output capacitor is selected according to output ripple which is calculated as below equation.

$$\Delta V_{OUT} = \Delta V_{ESR} + \Delta V_{OUT_{CAP}}$$
$$\Delta V_{ESR} = I_{C_{RMS}} \times R_{C_{ESR}}$$
$$\Delta V_{OUT_{CAP}} = \frac{I_{OUT} \times Duty}{f_{SW} \times C_{MIN}}$$

User can use equation choose capacitor to meeting systems ripple specification. And at least 22μ F x 2 capacitors is recommended to matching application with VOUT ripple request and stability performance.

Table 2. Protection Trigger Condition and Behavior

The RT6160A features some protections, such as OCP, OVP, UVLO, OTP and UVP. As the table shown, it is described the protection actions.

| Protection Type | Threshold Refer to Electrical Spec. | Deglitch Time | Protection Method | Reset Method |
|------------------|--|------------------|--|---|
| OCP (Note 11) | I _L > 5A | 0 | Turn off Boost LG or Turn off Buck UG | IL < 4.5A |
| UVLO | V _{IN} < 2.08V (max) | 0 | Turn off all | V _{IN} > 2.17V (max) |
| OTP | TEMP > 150°C | 0 | Turn off all | OTP Hysteresis = 20°C |
| OVP | V _{OUT} > 6V | 0 | Turn off all | V _{OUT} < 5.6V |
| UVP | V _{OUT} < 0.9 x V _{OUT_Target} | 2ms | Turn off all | V _{OUT} > 0.95 x V _{OUT_Target} |

Note 11. Turn off all switches when OCP event occurs and is continuing for 2ms.

Over-Current Protection

The OCP function is implemented by UGATE and LGATE. When the inductor current reaches the UGATE current limit threshold, the high-side MOSFET will be turned-off. The low-side MOSFET turns on to discharge the inductor current until the inductor current trips below the LGATE current limit threshold. After UGATE current limit triggered, the max inductor current is decided by the inductor current rising rate and the response delay time of the internal network.

Input UVLO Protection

In addition to the EN pin, the RT6160A also provides enable control through the VIN pin. If V_{EN} rises above V_{ENH} first, switching will still be inhibited until the V_{IN} voltage rises above V_{UVLO}. It is to ensure that the internal regulator is ready so that operation with notfully-enhanced internal MOSFET switches can be prevented. After the device is powered up, if the V_{IN} voltage goes below the UVLO falling threshold voltage (V_{UVLO} - Δ V_{UVLO}), this switching will be inhibited; if V_{IN} voltage rises above the UVLO rising threshold (V_{UVLO}), the device will resume switching.

Over-Temperature Protection

When the junction temperature exceeds the OTP threshold value, the IC will shut down the switching operation. Once the junction temperature cools down and is lower than the OTP lower threshold, the converter will automatically resume switching. When the device detects an over-temperature condition, it sets the

TSD bit in the Status register to 1. The device clears the TSD bit to 0 if you read the Status register when the junction temperature of the device is less than 130°C.

Over-Voltage Protection

When the VOUT pin is floating, the device will trigger the over-voltage protection to avoid the output voltage exceeding critical values for device. In case it reaches the OVP threshold, the device will regulate the output voltage to this value.

Under-Voltage Protection

The RT6160A provides Hiccup Mode for Under-Voltage Protection (UVP). When the V_{OUT} voltage drops below 90% of Target V_{OUT}, the UVP function will be triggered to shut down switching operation. If the UVP condition remains for a period, the RT6160A will retry to build up output voltage automatically. When the UVP condition is removed, the converter will soft-start to target voltage and resume normal operation.

Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature $T_{J(MAX)}$, listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula :

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$\mathsf{P}_{\mathsf{D}(\mathsf{MAX})} = (\mathsf{T}_{\mathsf{J}(\mathsf{MAX})} - \mathsf{T}_{\mathsf{A}}) \ / \ \theta_{\mathsf{JA}}$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction-toambient thermal resistance.

For continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-ambient thermal resistance, θ_{JA} , is highly package dependent. For a WL-CSP-15B 1.4x2.3 (BSC) package, the thermal resistance, θ_{JA} , is 53°C/W on a standard JEDEC 51-7 high effective-thermal conductivity four-layer test board. The maximum power dissipation at $T_A = 25$ °C can be calculated as below :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (53^{\circ}C/W) = 1.88W$ for a WL-CSP-15B 1.4x2.3 package.

The maximum power dissipation depends on the operating ambient temperature for the fixed T_{J(MAX)} and the thermal resistance, θ_{JA} . The derating curves in Figure 6 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

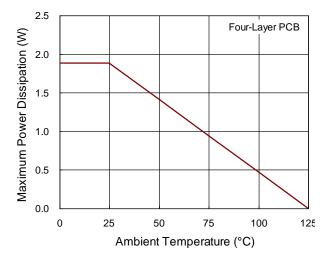


Figure 6. Derating Curve of Maximum Power Dissipation

Layout Considerations

For best performance of the RT6160A, the following layout guidelines must be strictly followed.

- Input capacitor must be placed as close as possible to IC to minimize the power loop area. A typical 0.1µF decoupling capacitor is recommended to reduce power loop area and any high frequency component on VIN.
- Switching node (LX1 and LX2) are with high frequency voltage swing and should be kept at small area. Keep analog components away from the LX1 and LX2 node to prevent stray capacitive noise pickup.
- Keep every power trace connected to pin as wide as possible for improving thermal dissipation.
- ► The AGND pin is suggested to connect to 2nd GND plate through top to 2nd via.

RT6160A

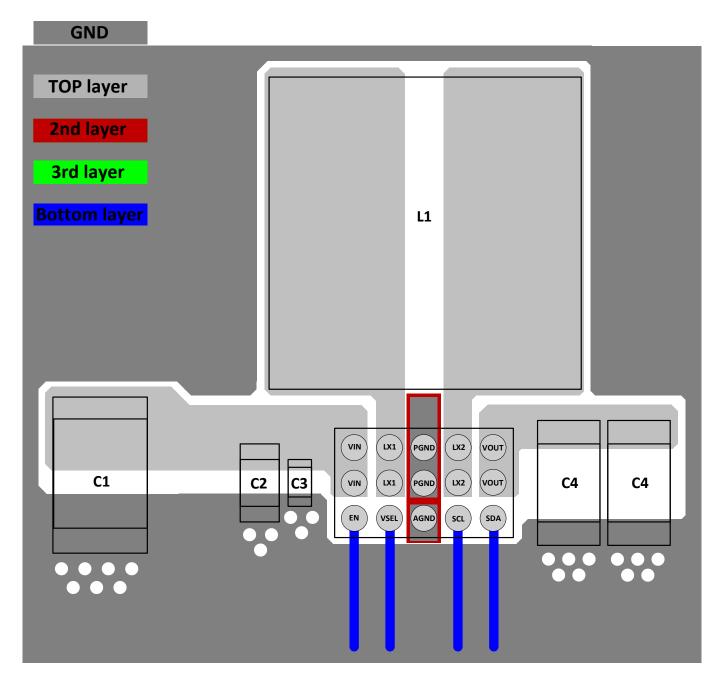


Figure 7. Layout Guide





I²C Interface

The following table shows the RT6160A slave address 0x75(7bit).

| RT6160A I ² C Slave Address (75H) | | | | | | |
|--|---|-----|-------|--|--|--|
| MSB LSB R/W bit R/W | | | | | | |
| 111010 | 1 | 1/0 | EB/EA | | | |

The I²C interface bus must be connect a resistor $2.2k\Omega$ to power node and independent connection to processor, individually. The I²C timing diagrams are listed below.

Read and Write Function

Read single byte of data from Register Slave Address Register Address Slave Address MSB Data LŞB s 0 A A Sr Ā Р Α ≜ Assume Address = m Data for Address = m R/W-Read N bytes of data from Registers Slave Address Register Address Slave Address MSB Data 1 LŞB S A Sr 0 A A R/₩_ Assume Address = m Data for Address = m MŞB MŞB Data 2 LSB Data N LŞB Р Ā A Data for Address = m + 1 Data for Address = m + N -Write single byte of data to Register Slave Address Register Address MSB LSB Data S Ρ 0 А A А Assume Address = m Data for Address = m R/W Ĵ Write N bytes of data to Registers Register Address MSB MSB Slave Address Data 1 LSB LSB Data 2 S A А Α 0 A ≜ Assume Address = m Data for Address = m Data for Address = m + 1 R/W MŞB Data N LŞB Ρ Α Data for Address = m + Ν Driven by Master, Driven by Slave, P Stop, S Start, Sr Repeat Start

I²C Waveform Information

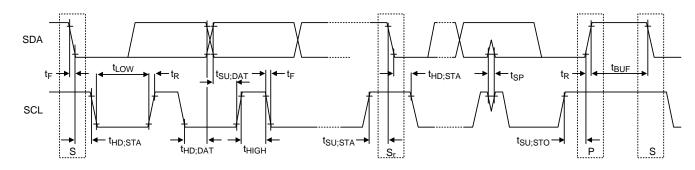


Figure 8. I²C Read and Write Stream and Timing Diagram

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| 22 | | | | |

Register Table Lists

| Name | Address | Description |
|---------|---------|---|
| CONTROL | 0x01 | Output pull-down slew rate control MODE function control DVS slew rate function control |
| STATUS | 0x02 | Read IC status |
| DEVID | 0x03 | Device Identity |
| VOUT1 | 0x04 | Output Voltage 1 when the VSEL pin is low |
| VOUT2 | 0x05 | Output Voltage 2 when the VSEL pin is High |

Register Descriptions

 I^2C Slave address = 1110101 (75H)

I²C Register Map

R : Read Only

RW : Read and Write

| Address 0x01 | | | | CON | TROL | | | |
|--------------|----------|---------------------|----------|---------------------|---------------|-----|-------|---------|
| Bits | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Name | Reserved | I ² C_SD | A_SLEW | Ultra-Sonic Mode | Forced PWM | | | ew Rate |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Туре | R | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| Address 0x02 | | | | STA | TUS | | | |
| Bits | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Name | | Reserved | | HD | UV | OC | TSD | PG |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Туре | R | R | R | R | R | R | R | R |
| Address 0x03 | | | | DE | VID | | | |
| Bits | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Name | | Manu | facturer | Major | | | Minor | |
| Reset | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 0 |
| Туре | R | R | R | R | R | R | R | R |
| Address 0x04 | | | | VO | UT1 | | | |
| Bits | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Name | Reserved | | | | VOUT1 | | | |
| Reset | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 |
| Туре | R | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| Address 0x05 | | | | VO | UT2 | | | |
| Bits | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Name | Reserved | | | | VOUT2 | | | |
| Reset | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 1 |
| Туре | R | R/W | R/W | R/W | R/W | R/W | R/W | R/W |

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| Address | Register Name | Bit | Bit Name | ne Default Type Description | | Description |
|---------|------------------|-----|---------------------------|-----------------------------|------|--|
| | | 7 | Reserved | 0 | R | Reserved |
| | | 6:5 | I ² C_SDA_SLEW | 00 | R/W | SDA pin output pull-down slew rate 00 : High (default) 01 : Medium 10 : Low 11 : Very low |
| | | 4 | Ultra-Sonic Mode | 0 | R/W | This bit controls the ultra-sonic mode function. 0 : Ultra-Sonic mode disabled (default) 1 : Ultra-Sonic mode enabled |
| 0x01 | CONTROL | 3 | Forced PWM | 0 | R/W | This bit controls the forced-PWM mode function. 0 : Forced PWM operation disabled (default) 1 : Forced PWM operation enabled |
| | | 2 | Ramp PWM | 0 | R/W | This bit controls the ramp-PWM function. 0 : Ramp-PWM operation disabled (default) 1 : Ramp-PWM operation enabled |
| | | | DVS Slew Rate | 00 | R/W | These bits control the slew rate of the DVS function. 00 : 1.0V/ms (default) 01 : 2.5V/ms 10 : 5.0V/ms 11 : 10.0V/ms |
| Address | Register Name | Bit | Bit Name | Default | Туре | Description |
| | | 7:5 | Reserved | 000 | R | Reserved |
| | | 4 | HD | 0 | R | This bit shows the status of the hot-die function. 0 : Normal operation (default) 1 : An hot-die event was detected |
| | | 3 | UV | 0 | R | This bit shows the status of the under voltage function. 0 : Normal operation (default) 1 : An under-voltage event was detected |
| 0x02 | STATUS | 2 | oc | 0 | R | This bit shows the status of the over current function. 0 : Normal operation (default) 1 : An over-current event was detected |
| | | 1 | TSD | 0 | R | This bit shows the status of the thermal shutdown function. 0 : Temperature good (default) 1 : An over-temperature event was detected |
| | | 0 | PG | 0 | R | This bit shows the status of the power-good comparator. 0 : Power-good(default) 1 : A power-not-good was detected |

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RT6160A

| Address | Register Name | Bit | Bit Name | Default | Туре | Description |
|---------|------------------|-----|--------------|---------|------|--|
| | | 7:4 | Manufacturer | 1010 | R | These bits identify the device manufacturer. 1010 : Richtek (default) |
| 0x03 | DEVID | 3:2 | Major | 10 | R | These bits identify the major silicon revision. 00 : A (initial silicon) 01 : B (first major revision) 10 : C (second major revision) (default) 11 : D (third major revision) |
| | | 1:0 | Minor | 00 | R | These bits identify the minor silicon revision. 00 : 0 (initial silicon) (default) 01 : 1 (first minor revision) 10 : 2 (second minor revision) 11 : 3 (third minor revision) |
| Address | Register Name | Bit | Bit Name | Default | Туре | Description |
| | | 7 | Reserved | 0 | R | Reserved |
| 0x04 | VOUT1 | 6:0 | VOUT1 | 0110011 | R/W | These bits set the output voltage when the VSEL pin is low. $0000000 : V_{OUT} = 2.025V$ $0000001 : V_{OUT} = 2.05V$ $0000010 : V_{OUT} = 2.075V$ $0110011 : V_{OUT} = 3.3V$ (default) $1111101 : V_{OUT} = 5.15V$ $1111110 : V_{OUT} = 5.175V$ $1111111 : V_{OUT} = 5.2V$ |
| Address | Register Name | Bit | Bit Name | Default | Туре | Description |
| | | 7 | Reserved | 0 | R | Reserved |
| 0x05 | VOUT2 | 6:0 | VOUT2 | 0111001 | R/W | These bits set the output voltage when the VSEL pin is High. 0000000 : Vout = 2.025V 0000001 : Vout = 2.05V 0000010 : Vout = 2.075V 0111001 : Vout = 3.45V (default) 1111101 : Vout = 5.15V 1111110 : Vout = 5.175V 1111111 : Vout = 5.2V |

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Table 3. Register VOUT1/VOUT2[6:0] vs. Output Voltage

VOUT1 Address = 0x04, Output Voltage 1 when the VSEL pin is low.

VOUT2 Address = 0x05, Output Voltage 2 when the VSEL pin is high.

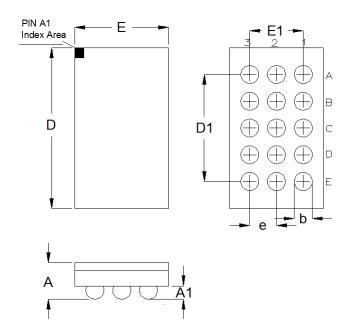
| Register VOUT[6:0] | Output Voltage (V) |
|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|
| 0000000 | 2.025 | 0100000 | 2.825 | 1000000 | 3.625 | 1100000 | 4.425 |
| 0000001 | 2.05 | 0100001 | 2.85 | 1000001 | 3.65 | 1100001 | 4.45 |
| 0000010 | 2.075 | 0100010 | 2.875 | 1000010 | 3.675 | 1100010 | 4.475 |
| 0000011 | 2.1 | 0100011 | 2.9 | 1000011 | 3.7 | 1100011 | 4.5 |
| 0000100 | 2.125 | 0100100 | 2.925 | 1000100 | 3.725 | 1100100 | 4.525 |
| 0000101 | 2.15 | 0100101 | 2.95 | 1000101 | 3.75 | 1100101 | 4.55 |
| 0000110 | 2.175 | 0100110 | 2.975 | 1000110 | 3.775 | 1100110 | 4.575 |
| 0000111 | 2.2 | 0100111 | 3 | 1000111 | 3.8 | 1100111 | 4.6 |
| 0001000 | 2.225 | 0101000 | 3.025 | 1001000 | 3.825 | 1101000 | 4.625 |
| 0001001 | 2.25 | 0101001 | 3.05 | 1001001 | 3.85 | 1101001 | 4.65 |
| 0001010 | 2.275 | 0101010 | 3.075 | 1001010 | 3.875 | 1101010 | 4.675 |
| 0001011 | 2.3 | 0101011 | 3.1 | 1001011 | 3.9 | 1101011 | 4.7 |
| 0001100 | 2.325 | 0101100 | 3.125 | 1001100 | 3.925 | 1101100 | 4.725 |
| 0001101 | 2.35 | 0101101 | 3.15 | 1001101 | 3.95 | 1101101 | 4.75 |
| 0001110 | 2.375 | 0101110 | 3.175 | 1001110 | 3.975 | 1101110 | 4.775 |
| 0001111 | 2.4 | 0101111 | 3.2 | 1001111 | 4 | 1101111 | 4.8 |
| 0010000 | 2.425 | 0110000 | 3.225 | 1010000 | 4.025 | 1110000 | 4.825 |
| 0010001 | 2.45 | 0110001 | 3.25 | 1010001 | 4.05 | 1110001 | 4.85 |
| 0010010 | 2.475 | 0110010 | 3.275 | 1010010 | 4.075 | 1110010 | 4.875 |
| 0010011 | 2.5 | 0110011 | 3.3 | 1010011 | 4.1 | 1110011 | 4.9 |
| 0010100 | 2.525 | 0110100 | 3.325 | 1010100 | 4.125 | 1110100 | 4.925 |
| 0010101 | 2.55 | 0110101 | 3.35 | 1010101 | 4.15 | 1110101 | 4.95 |
| 0010110 | 2.575 | 0110110 | 3.375 | 1010110 | 4.175 | 1110110 | 4.975 |
| 0010111 | 2.6 | 0110111 | 3.4 | 1010111 | 4.2 | 1110111 | 5 |
| 0011000 | 2.625 | 0111000 | 3.425 | 1011000 | 4.225 | 1111000 | 5.025 |
| 0011001 | 2.65 | 0111001 | 3.45 | 1011001 | 4.25 | 1111001 | 5.05 |
| 0011010 | 2.675 | 0111010 | 3.475 | 1011010 | 4.275 | 1111010 | 5.075 |
| 0011011 | 2.7 | 0111011 | 3.5 | 1011011 | 4.3 | 1111011 | 5.1 |
| 0011100 | 2.725 | 0111100 | 3.525 | 1011100 | 4.325 | 1111100 | 5.125 |
| 0011101 | 2.75 | 0111101 | 3.55 | 1011101 | 4.35 | 1111101 | 5.15 |
| 0011110 | 2.775 | 0111110 | 3.575 | 1011110 | 4.375 | 1111110 | 5.175 |
| 0011111 | 2.8 | 0111111 | 3.6 | 1011111 | 4.4 | 1111111 | 5.2 |

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Outline Dimension

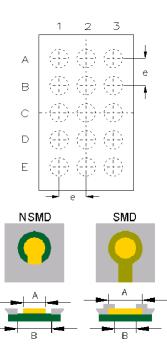


| Symbol | Dimensions | In Millimeters | Dimensions In Inches | | |
|--------|------------|----------------|-----------------------------|-------|--|
| Symbol | Min | Max | Min | Max | |
| А | 0.500 | 0.600 | 0.020 | 0.024 | |
| A1 | 0.170 | 0.230 | 0.007 | 0.009 | |
| b | 0.240 | 0.300 | 0.009 | 0.012 | |
| D | 2.260 | 2.340 | 0.089 | 0.092 | |
| D1 | 1.6 | 500 | 0.0 |)63 | |
| E | 1.360 | 1.440 | 0.054 | 0.057 | |
| E1 | 0.8 | 300 | 0.031 | | |
| е | 0.4 | 400 | 0.0 |)16 | |

15B WL-CSP 1.4x2.3 Package (BSC)



Footprint Information



| Dealeage | Number of | Tuno | Footpri | Toloropoo | | |
|-----------------------|-----------|------|---------|-----------|-------|-----------|
| Package | Pin | Туре | е | А | В | Tolerance |
| | 45 | NSMD | 0.400 | 0.240 | 0.340 | .0.025 |
| WL-CSP1.4x2.3-15(BSC) | 15 | SMD | 0.400 | 0.270 | 0.240 | ±0.025 |

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